- **%For use with TI's TNET D 4000 C/P chipset**
- **XExcellent THD performance**
- **%Small footprint**
- **X**Designed to meet UL 1950
- **※For RoHS part add suffix NL**
- **※RoHS NL** peak solder rating 235℃



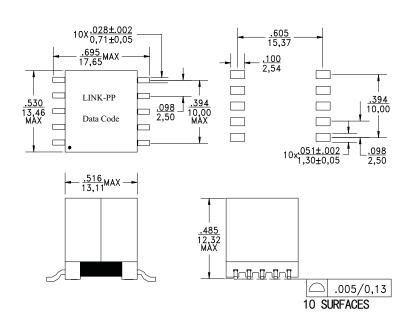


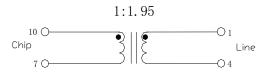
Electrical Specifications @ 25℃ Operating Temperature –40℃ to 85℃						
Part Number	Application	Mounting	Turns Ratio (±2%)(10-7):(1-4)	OCL @10KHz,0.1 (1-4) with (2-3) shorted	Leakage Inductance @10KHz, 0.1V (1-4) with (10-7),shorted	
LPA2132	CO	SMT	1:1.95(Chip to Line)	1.5 mH (± 10%)	12.0 μΗ MAX	

Additional Specifications							
Part Number	DC Resistance (1-4)(w/2-3 shorted)	Isolation Voltage (Vrms)	Interwinding capacitance @ 10KHz,0.1 V (1-10)				
LPA2132	2.0 Ω MAX	1500	35 pF MAX				

Mechanical **Schematic** 

## LPA2132





Dimensions: Inches Unless otherwise specified, all tolerances are  $\pm \frac{.010}{0,25}$